

Data issued: May 4, 2022
Valid period: 12 months

Bulletin

We, CHIMEI CORPORATION, to the best of our knowledge hereby certify that the resins listed below (hereinafter referred as "products") as directly manufactured by us

POLYLAC® ABS (J01)

PA-704LRP, PA-705, PA-707, PA-709, PA-709H, PA-709K, PA-709P, PA-709S, PA-716, PA-717C, PA-718, PA-726, PA-726M, PA-727, PA-737, PA-737 A03, PA-746, PA-746H, PA-746M, PA-746Y, PA-747, PA-747F, PA-747H, PA-747R, PA-747S, PA-747S A01, PA-749, PA-749S, PA-756, PA-756S, PA-756H, PA-757, PA-757 A01, PA-757 AB, PA-757F, PA-757G J08, PA-757H, PA-757N, PA-757K, PA-777B, PA-777C, PA-777D, PA-777E, PA-77NB, PA-797, PA-797S

(J01) - The suffix may be used to denote the black color grade manufactured from Chi Mei Corp.

(A01 & A03) - The suffix may be used to denote the white color grade manufactured from Chi Mei Corp.

POLYLAC® MABS

PA-703TRP, PA-758, PA-758R, LS-L230

KIBISAN® SAN

PN-106, PN-107, PN-117, PN-117C, PN-117H, PN-127, PN-127H, PN-137H, PN-106 L150 FG, PN-107 L125 FG, PN-117 L200 FG, PN-127 L150 FG

POLYREX® PS

PG-22, PG-33, PG-80, PG-80N, PG-383, PG-383D, PH-55Y, PH-60, PH-88, PH-88S, PH-888G, PH-888H, PH-88SF

ACRYREX® PMMA

CM-203, CM-205, CM-205G, CM-205N, CM-207, CM-207G, CM-211, CM-211G

ACRYSTEX® SMMA

PM-500, PM-500G, PM-600, PM-700G

KIBITON® TPE

PB-511, PB-575, PB-585, PB-587, PB-5300, PB-5301, PB-5302, PB-5308, PB-5502

KIBITON® Q-resin

PB-5630, PB-5900, PB-5903, PB-5906, PB-5910, PB-5925

KIBIPOL® LBR/SSBR/HBR

PR-040, PR-040C, PR-040G, PR-040S, PR-050, PR-060S, PR-245, PR-255, PR-303, PR-1205

ACRYPOLY®

CM-205B, CM-205X, PM-500X, LM-700X

The above statement is based on our current level of knowledge and covers the above products directly manufactured and supplied by CHIMEI CORPORATION at the date of issue. CHIMEI CORPORATION makes no warranties, whether express or implied, and assumes no liability in connection with any use of above information. Notwithstanding the foregoing, CHIMEI CORPORATION shall in no event be held obligated or liable for any claims due to or arising from (i) any customer provided, consigned, materials and/or parts, which are incorporated or adopted in the products; (ii) any combination of the products with material not provided or authorized by our company; (iii) any modifications to the products which are made or directed by customer; (iv) our compliance with the specifications, instructions, and/or designs provided by customer; (v) any anti-trust, unfair competition and/or other unlawful actions effected by customer; or (vi) any defects, infringement, breach and/or violation which are arising out of customer's faults or otherwise not solely and directly attributable to CHIMEI CORPORATION. In no event will CHIMEI CORPORATION be liable for any indirect, special, exemplary, punitive, or consequential damages (including lost profits) of any nature whatsoever whether arising out of the purchase, shipment, unloading, handling, or use of any product or otherwise.

KIBILITE®

DC-552F, DC-552G, DC-553F, DC-603F, DM-000B, DM-551M,
DM-553B, DM-601M, DM-601R, DS-551A, DS-553A, DS-553C,
DS-553H, DS-601S, DS-601Y, DS-603A, DS-603C, DS-653A,
DS-653C, DS-743B, DS-753B, DS-903A, DS-903E, DS-903H,
DS-943A, DS-943B, DS-943G, DS-943H, DS-943I, DS-963E,
DS-963G

KIBILAC®

PW-957, PW-978B, PW-997, PW-997G, PW-997S

conforms to the requirement that no chemicals as following are added.

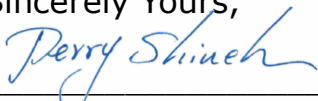
1. Halogen (F, Br, I) and its compounds
2. Halogen (Cl)
3. PBDEs (Polybrominated Diphenyl Ethers)
4. PBBs (Polybrominated Biphenyls)
5. Ozone Depleting Chemicals (CFCs & HCFCs)
6. Chlorinated Paraffin (C10-C13)
7. Polyvinyl Chloride (PVC)
8. Mercury (Hg) and its compounds
9. Lead (Pb) and its compounds
10. Cadmium (Cd) and its compounds
11. Chromium (Cr) and its compounds
12. Arsenic (As) and its compounds
13. Antimony (Sb) and its compounds
14. Selenium (Se) and its compounds
15. Barium (Ba) and its compounds
16. Beryllium (Be) and its compounds
17. Bismuth (Bi) and its compounds
18. Organic tin compounds (TBT, TPT, DOT, DBT)
19. Polychlorinated Biphenyls (PCBs) and Terphenyls (PCTs) and Naphtalenes (PCNs)
20. Poly naphthalenes
21. Azo colorants (according to REACH-ANNEX-XVII-APPENDIX 8)
22. Asbestos
23. Phthalates
24. APEO: Including Alkylphenol(AP), Octylphenol(OP), Nonylphenol(NP), Octylphenol ethoxylates(OPE), Nonylphenol ethoxylates(NPE)
25. 2-(2'-Hydroxy-3',5'-di-tert-butylphenyl)benzotriazole
26. PFOA and its compounds, PFOS and its compounds
27. Perchlorate
28. Hexachlorobenzene
29. Mirex
30. Specified amine compounds
31. Benzene
32. Benzenamine, N-phenyl-, Reaction Products with Styrene and 2,4,4-Trimethylpentene (BNST)
33. Polyamide
34. PVDC (polyvinylidene chloride)
35. ESBO (Expoxidized soybean oil)
36. Formamide
37. Hexabromocyclododecane (HBCDD)
38. Red phosphorus
39. Aniline · formaldehyde polycondensate
40. Fluorescent powder
41. 4,4'-Sulfonyldiphenol (BPS)
42. Tris(1-chloro-2-propyl)phosphate (TCPP)
43. Tris(1,3-dichloro-2-propyl)phosphate (TDCPP)
44. Tris (2,3-dibromopropyl) phosphate
45. Tris (aziridiny) phosphin oxide
46. Tri-o-cresyl phosphate
47. Tris (2-chloroethyl) phosphate (TCEP)
48. Perfluorohexane-1-sulphonic acid and its salts (PFHxS)
49. Diisononyl phthalate (DINP)
50. Di-isodecyl phthalate (DIDP)
51. Di-n-octyl phthalate (DnOP)
52. Diethyl phthalate (DEP)
53. Dimethyl phthalate (DMP)
54. Cobalt
55. Mica
56. Graphite

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|-----------------------------------|-----------------------------------------------------|
| 27. Bisphenol A | 67. Bis (2-ethylhexyl) phthalate (DEHP) |
| 28. Formaldehyde | 68. Butyl benzyl phthalate (BBP) |
| 29. Dimethylfumarate (DMF) | 69. Dibutyl phthalate (DBP) |
| 30. Triclosan | 70. Diisobutyl phthalate (DIBP) |
| 31. Nickel | 71. PIP (3:1) (phenol, isopropylated phosphate 3:1) |
| 32. REACH- Candidate List of SVHC | 72. DecaBDE (decabromodiphenyl ether) |
| 33. Radioactive Substances | 73. 2,4,6-TTBP (2,4,6-Tris(tert-butyl)phenol) |
| 34. Natural Latex | 74. HCBd (hexachlorobutadiene) |
| 35. Dioxins and furans | 75. PCTP (pentachlorothiophenol) |
| 36. Primary aromatic amines (PAA) | |

With regard to composition of above grades of products, the aforesaid products comply with the Directives of RoHS 2011/65/EU and its amendment (EU) 2015/863, TCO'07, Blue Angel and SONY Standard (SS-00259)

Sincerely Yours,



Perry D. B. Shiueh
Vice President of R&D Division

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